Unit: mm

TOSHIBA Insulated Gate Bipolar Transistor Silicon N Channel IGBT

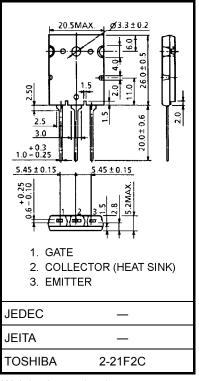
# GT25Q301

## High Power Switching Applications Motor Control Applications

- Third-generation IGBT
- Enhancement mode type
- High speed:  $t_f = 0.32 \mu s \text{ (max)}$
- Low saturation voltage: VCE (sat) = 2.7 V (max)
- FRD included between emitter and collector

### **Absolute Maximum Ratings (Ta = 25°C)**

Characteristics		Symbol	Rating	Unit	
Collector-emitter voltage		V <sub>CES</sub>	1200	V	
Gate-emitter voltage		V <sub>GES</sub>	±20	V	
Collector current	DC	IC	25	Α	
	1 ms	ICP	50		
Diode forward current	DC	lF	25	Α	
	1 ms	I <sub>FP</sub>	50	ζ	
Collector power dissipation (Tc = 25°C)		PC	200	W	
Junction temperature		Tj	150	°C	
Storage temperature range		T <sub>stg</sub>	-55 to 150	°C	

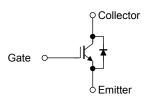


Weight: 9.75 g (typ.)

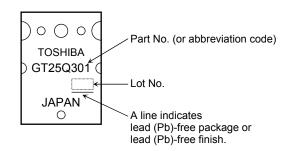
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Equivalent Circuit**



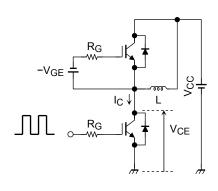
#### Marking

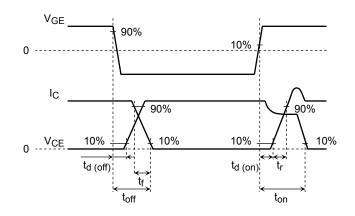


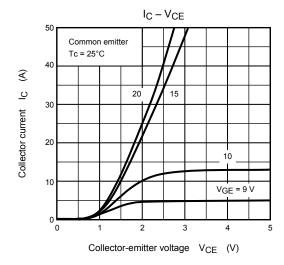
## **Electrical Characteristics (Ta = 25°C)**

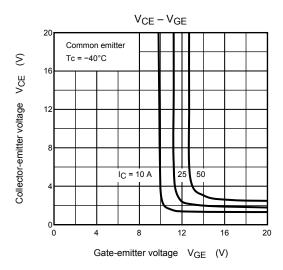
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I <sub>GES</sub>	V <sub>GE</sub> = ±20 V, V <sub>CE</sub> = 0	_	_	±500	nA
Collector cut-off current		I <sub>CES</sub>	V <sub>CE</sub> = 1200 V, V <sub>GE</sub> = 0	_	_	1.0	mA
Gate-emitter cut-off voltage		V <sub>GE</sub> (OFF)	I <sub>C</sub> = 2.5 mA, V <sub>CE</sub> = 5 V	4.0	_	7.0	V
Collector-emitter saturation voltage		V <sub>CE</sub> (sat)	I <sub>C</sub> = 25 A, V <sub>GE</sub> = 15 V	_	2.1	2.7	٧
Input capacitance		C <sub>ies</sub>	V <sub>CE</sub> = 50 V, V <sub>GE</sub> = 0, f = 1 MHz	_	1360	_	pF
Switching time	Rise time	t <sub>r</sub>	Inductive load $V_{CC} = 600 \text{ V, I}_{C} = 25 \text{ A}$ $V_{GG} = \pm 15 \text{ V, R}_{G} = 43 \Omega \qquad \text{(Note)}$		0.10	_	μs
	Turn-on time	t <sub>on</sub>		_	0.30	_	
	Fall time	t <sub>f</sub>		ı	0.16	0.32	
	Turn-off time	t <sub>off</sub>		_	0.68	_	
Diode forward voltage		V <sub>F</sub>	I <sub>F</sub> = 25 A, V <sub>GE</sub> = 0	_	_	3.0	V
Reverse recovery time		t <sub>rr</sub>	I <sub>F</sub> = 25 A, di/dt = -200 A/µs	_	_	350	ns
Thermal resistance (IGBT)		R <sub>th (j-c)</sub>	_	_	_	0.625	°C/W
Thermal resistance (diode)		R <sub>th (j-c)</sub>	_	_	_	1.38	°C/W

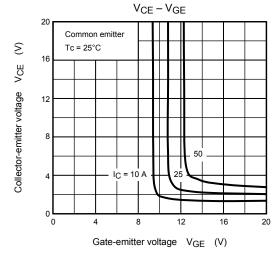
Note: Switching time measurement circuit and input/output waveforms

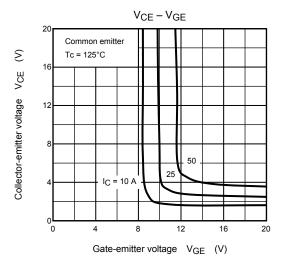


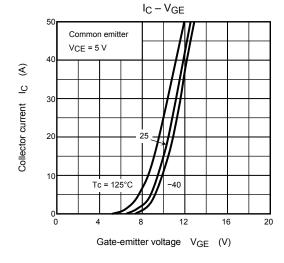


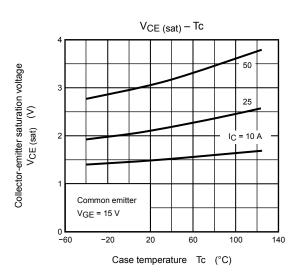




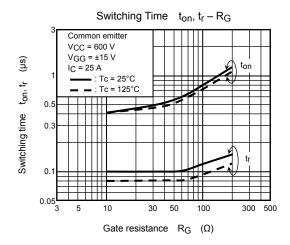


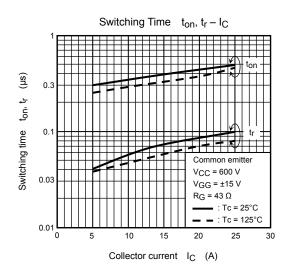


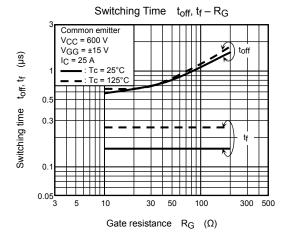


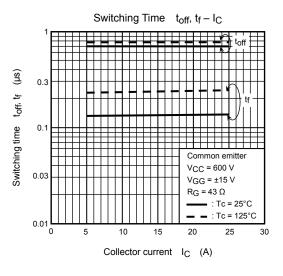


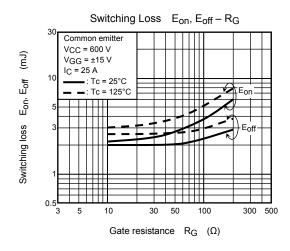
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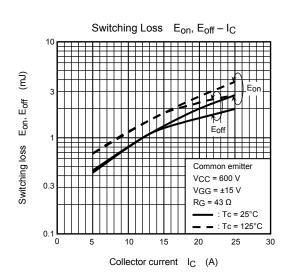


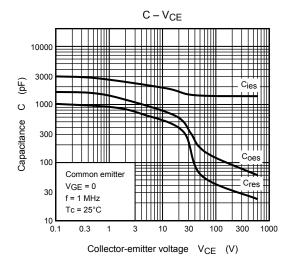


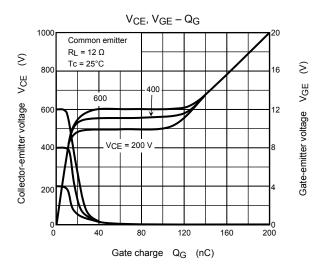


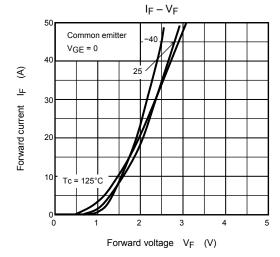


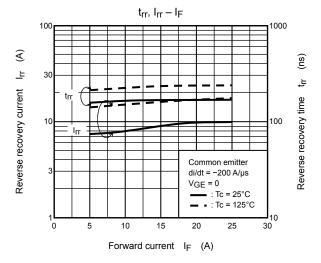


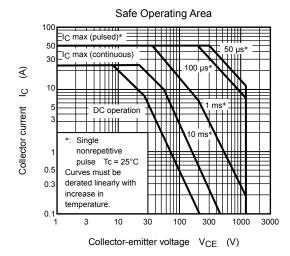


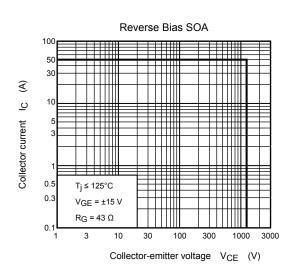




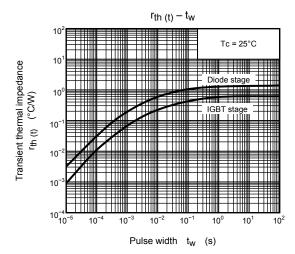








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